L Number	Hits	Search Text	DB	Time stamp
1	10648	laser adj2 (marking ablating manufacturing etching)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:15
2	17796	(laser adj beam) near3 (detect$3 sens$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:16
3	145238	(object product target) near2 (indicat$3 signal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:31
4	15	(laser adj2 (marking ablating manufacturing etching)) and ((laser adj beam) near3 (detect$3 sens$3)) and ((object product target) near2 (indicat$3 signal))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:22
5	3	("5334540" | "5541416" | "6081127").PN.	USPAT	2004/02/25 11:18
6	0	6541987.URPN.	USPAT	2004/02/25 11:20
7	1233	((laser adj beam) near3 (detect$3 sens$3)) and ((object product target) near2 (indicat$3 signal))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:22
8	1218	(((laser adj beam) near3 (detect$3 sens$3)) and ((object product target) near2 (indicat$3 signal))) not ((laser adj2 (marking ablating manufacturing etching)) and ((laser adj beam) near3 (detect$3 sens$3)) and ((object product target) near2 (indicat$3 signal)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:22
9	146	((laser adj beam) near3 (detect$3 sens$3)) same ((object product target) near2 (indicat$3 signal))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:22
10	142	(((laser adj beam) near3 (detect$3 sens$3)) same ((object product target) near2 (indicat$3 signal))) not ((laser adj2 (marking ablating manufacturing etching)) and ((laser adj beam) near3 (detect$3 sens$3)) and ((object product target) near2 (indicat$3 signal)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/02/25 11:23
11	9	("3745354" | "3949363" | "4877948" | "5452379" | "5481096" | "5525788" | "6016961" | "6135352" | "6325289").PN.	USPAT	2004/02/25 11:25
12	0	6502750.URPN.	USPAT	2004/02/25 11:26

C:\EAST Setup1.wsp